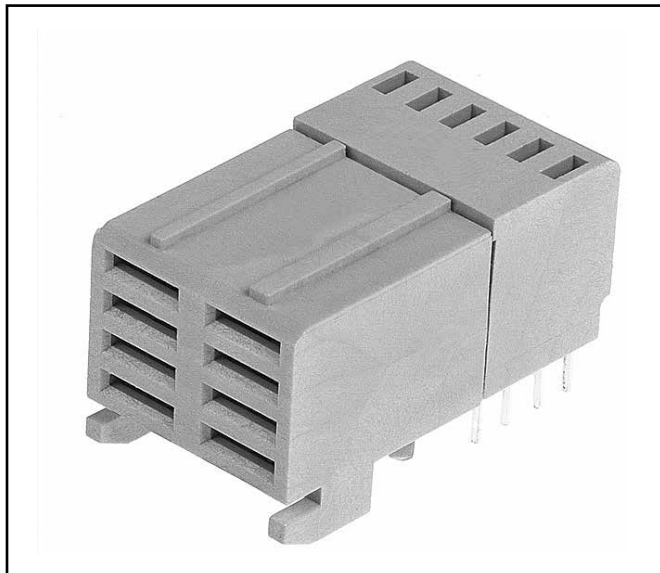


# 3M™ MetPak™ 2-FB Power Socket

2 mm 4/5-Row, Right Angle, Solder or Press-Fit Tail

MP2 Series



- 6.50 Amps per contact
- End-to-end stackable
- Press or heat stake peg (solder tail)
- Futurebus+® compatible
- See the Regulatory Information Appendix (RIA) in the “RoHS compliance” section of [www.3Mconnectors.com](http://www.3Mconnectors.com) for compliance information (RIA E1 & C1 apply)

Date Modified: February 14, 2017

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## Physical

### Insulation:

Material: High Temperature LCP  
Flammability: UL 94V-0  
Color: Beige

### Contact:

Material: Copper Alloy

### Plating:

Underplating: 50 μ” [1.27 μm] Nickel  
Wiping Area: See Ordering Information  
Tails: See Ordering Information

## Electrical

**Current Rating:** Power: 6.50 A per power socket contact at 70°C  
**Insulation Resistance:** 10<sup>3</sup> MΩ  
**Withstanding Voltage:** 1,500 V<sub>AC</sub> for 60 seconds

## Environmental

**Temperature Rating:** -55° C to 125° C  
**Process Temperature Rating:** 260°C (Profile per J-STD-020C)  
**Moisture Sensitivity Level:** 1 (per J-STD-020C)

UL File No.: E68080

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**3M**  
Electronics Materials Solutions Division  
Interconnect Solutions  
<http://www.3Mconnectors.com>

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**800-225-5373**

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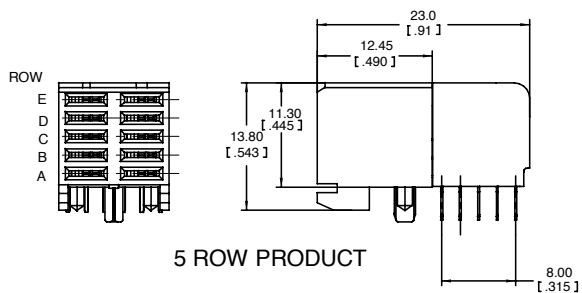


FOR SPECIAL MONOBLOCKS  
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REPRESENTATIVE



Tolerance Unless Noted		
	mm	Inch
	0	0.00
	±3	±0.13

( ) Dimensions used for Reference Only



5 ROW PRODUCT

**Note:**

1. Refer to IEC 61076-4-104 Futurebus+® global standard.
2. "Press Fit" describes a contact tail having a compliant section designed to make a reliable electrical connection with a plated through-hole (PTH) in a printed circuit board, typically a "back plane."

## Ordering Information

**MP2-SPXX-X1XX-XXXX**

SP = Power Socket

Contact Count  
(See Table 1)

Rows  
4 = 4 Rows  
5 = 5 Rows

Plating Options:  
(See Table 3)

Tail Length  
(See Table 2)

Termination Style  
P = Press-Fit  
M = Solder Tail (Press Peg)

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# 3M™ MetPak™ 2-FB Power Socket

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MP2 Series

Table 1	
Pin Count	No of Rows
08	4
10	5

Table 2 - Tail & Post Lengths			
Contact-to-PC Board Tail Termination Option No.		Dim. "A"	Dim. "B"
Solder	Press-Fit*		
S1		2.72 [0.107]	5.20 [0.205]
S2		3.53 [0.139]	6.00 [0.256]
M1		2.72 [0.107]	3.75 [0.148]
M2	P1	3.53 [0.139]	3.75 [0.148]

\*Compliant-Pin Tail

Table 3 - Plating			
Plating Suffix	Press-Fit Tails*	Solder Tails	Plating Composition
KR	RIA E1 & C1 apply	RIA E1 & C1 apply	0.76 μm [30 μ"] Min. Au Contact Area 2.54 μm [100 μ"] Min. Matt Whisker Mitigating Sn Tail Area 1.27 μm [50 μ"] Min. Ni all over
LR	RIA E1 & C1 apply	RIA E1 & C1 apply	0.08 μm [3 μ"] Min. Au Contact Area 0.67 μm [27 μ"] Min. PdNi Contact Area 2.54 μm [100 μ"] Min. Matt Whisker Mitigating Sn Tail Area 1.27 μm [50 μ"] Min. Ni all over

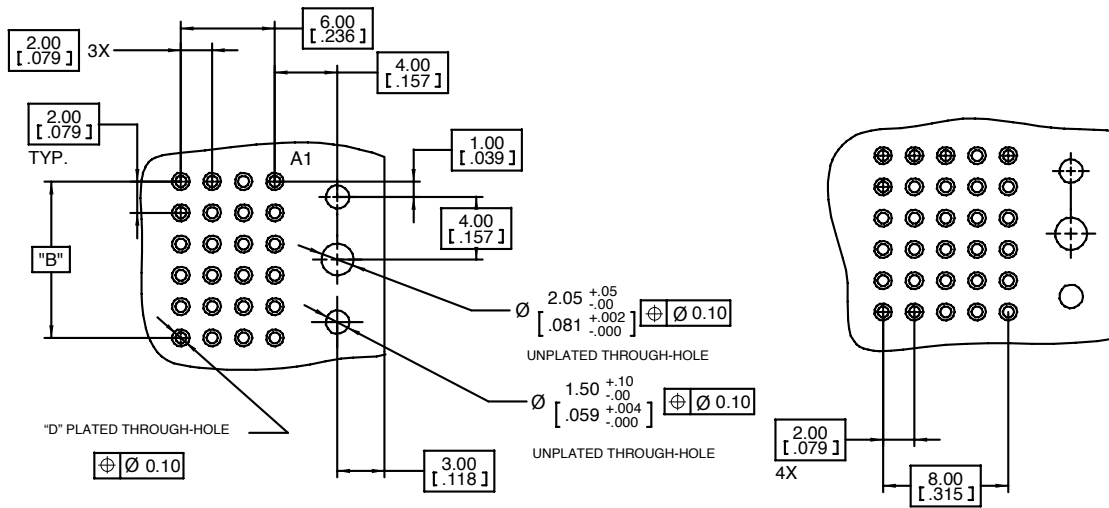
\*Compliant-Pin Tail

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# 3M™ MetPak™ 2-FB Power Socket

2 mm 4/5-Row, Right Angle, Solder or Press-Fit Tail

MP2 Series



**Recommended 4 Row PCB Hole Mounting Pattern**

**Recommended 5 Row PCB Hole Mounting Pattern**

**Table 4 - HOLE PLATING FINISHES**

HOLE	Finished Dia. mm [in]	Cu Thickness mm [in]	Immersion Matte Sn Thickness microns [μ"]	Electrolytic Au Thickness microns [μ"]	OSP ENTEK Thickness microns [μ"]	Drilled Hole Dia. mm [in]
"D"	0.700-0.800 [.0276-.0315]	0.025-0.045 [0.001-0.002]	0.5 - 2.5 [20 - 100]	0.1 - 0.5 [4 - 20]	0.2 - 0.5 [8 - 20]	0.830-0.860 [.0330-.0340] or 0.85mm [#66] TWIST DRILL

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